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Fairchild Semiconductor FQP30N06L

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Datasheet of FQP30N06L - MOSFET N-CH 60V 32A TO-220

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November 2013

FQP30N06L

N-Channel QFET® MOSFET **60 V, 32 A, 35 m**Ω

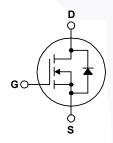
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 32 A, 60 V, $R_{DS(on)}$ = 35 mΩ (Max.) @ V_{GS} = 10 V, I_D = 16 A
- Low Gate Charge (Typ. 15 nC)
- Low Crss (Typ. 50 pF)
- · 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP30N06L	Unit
V_{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°C)		32	Α
	- Continuous (T _C = 100°C)	22.6	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	128	Α
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	350	mJ
I _{AR}	Avalanche Current	(Note 1)	32	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1) 7.9		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		7.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		79	W
	- Derate above 25°C		0.53	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQP30N06L	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.90	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	



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Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP30N06L	FQP30N06L	TO-220	Tube	N/A	N/A	50 units

Electrical Characteristics

T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.06		V/°C
I _{DSS}	Zana Oala Vallana Basin Oanad	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 48 V, T _C = 150°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.5	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$ $V_{GS} = 5 \text{ V}, I_D = 16 \text{ A}$		0.027 0.035	0.035 0.045	Ω
9 _{FS}	Forward Transconductance	e $V_{DS} = 25 \text{ V}, I_D = 16 \text{ A}$		24		S
Dynam	ic Characteristics					
C _{iss}	Input Capacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$			800	1040	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		270	350	pF
C _{rss}	Reverse Transfer Capacitance			50	65	pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 16 A,		15	40	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		210	430	ns
t _{d(off)}	Turn-Off Delay Time]	60	130	ns
t _f	Turn-Off Fall Time	(Note 4)	/	110	230	ns
Qg	Total Gate Charge	V _{DS} = 48 V, I _D = 32 A,		15	20	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V		3.5		nC
Q _{qd}	Gate-Drain Charge	(Note 4)		8.5		nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current		 	32	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	128	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 32 A	 //	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 32 A,	 60		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs	 90		nC

- **Notes:** 1. Repetitive Rating : Pulse width limited by maximum junction temperature. 2. L = 400 μ H, I_{AS} = 32 A, V_{DD} = 25 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \le$ 32 A, di/dt \le 300 A/us, $V_{DD} \le$ BV $_{DSS}$, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.



Typical Characteristics

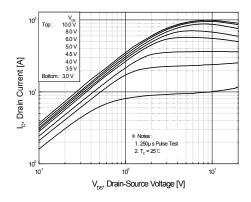


Figure 1. On-Region Characteristics

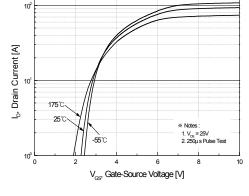


Figure 2. Transfer Characteristics

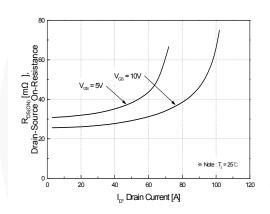


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

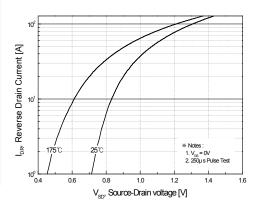


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

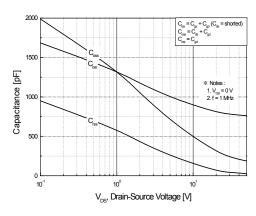


Figure 5. Capacitance Characteristics

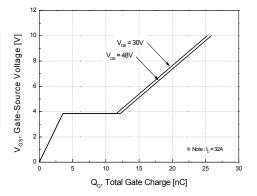
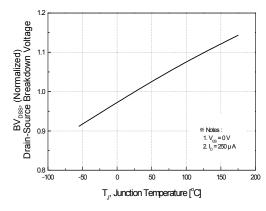


Figure 6. Gate Charge Characteristics

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Typical Characteristics (continued)



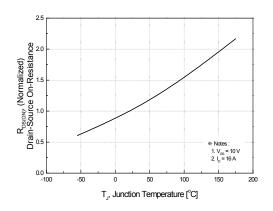
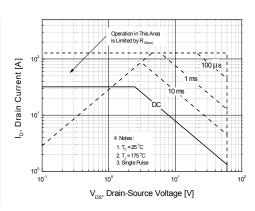


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



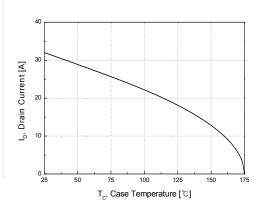


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

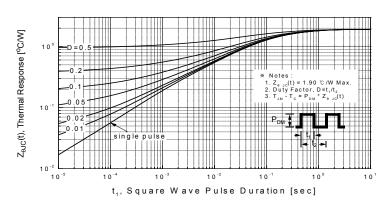
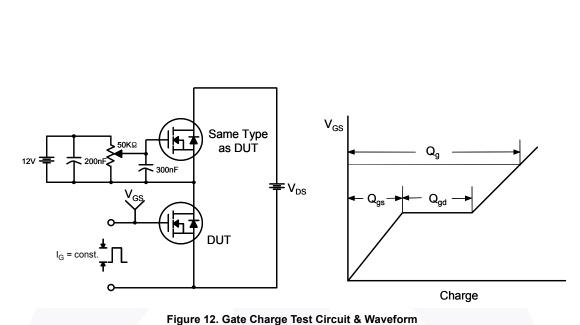


Figure 11. Transient Thermal Response Curve



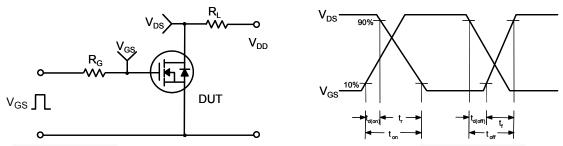


Figure 13. Resistive Switching Test Circuit & Waveforms

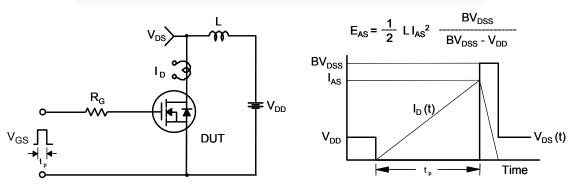
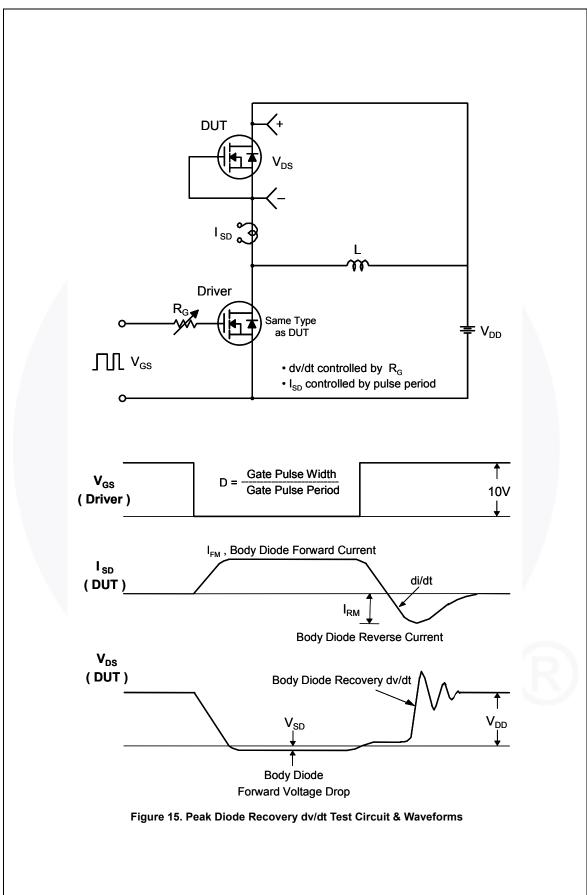


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Mechanical Dimensions

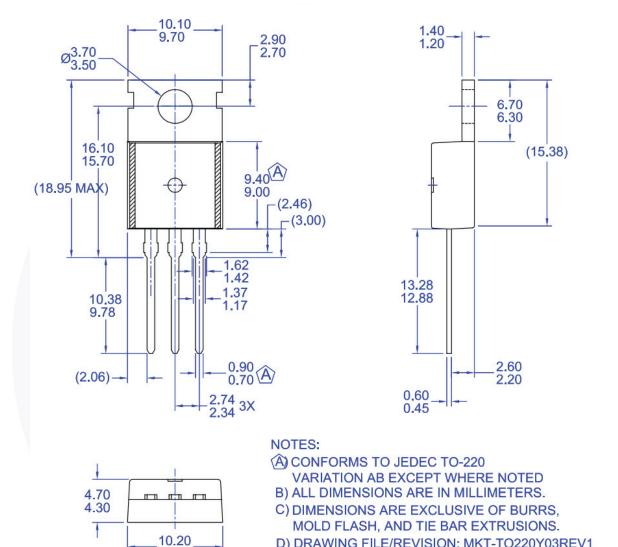


Figure 16. TO220, Molded, 3-Lead, Jedec Variation AB

D) DRAWING FILE/REVISION: MKT-TO220Y03REV1

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http://www.fairchildsemi.com/package/packageDetails.html?id=PN TO220-003

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